## **Preface**

It's a great privilege and pleasure for me to serve as the Editor In-chief for the IDES joint International conferences. Innovative ideas and research in two streams are extremely important for the current Electronics industry to be in support to "Digital India" and "Make in India" an initiative by Govt. of India. This joint International conference provides a rostrum to the researchers from the academia and industries all around the world to share their research results, novel ideas as well as the improvements over the existing methodology.



This conference cover the a wide verity of topics in control systems and power electronics, to name a few: Mobile Communication Technology, Natural Language Processing, Algorithm/protocol design and analysis, VLSI Systems, Intelligent Systems and Approach, Data Communication, Embedded System, Digital Security, Data Compression, Data Mining, Databases, Digital Signal Processing, Telecommunication Technologies, Control Theory and Application, Computational Intelligence, Robotics, HVDC, MEMS-Related Technology. The response from the researchers for the research papers is staggering.

Total 56 papers were registered for this joint International conference. Out of these 56 papers, one paper is registered for the Fifth International Conference on Advances in Design and Construction of Structures - ADCS 2016.

I would like to convey my heartfelt gratitude and appreciation to the members of the following committees; Honorary Chair, Technical Chair, Technical Co-Chair, General Chair, General Co-Chair, General Co-Chair, Publicity Chair, Publicity Co-Chair, Publication Chair, National Advisory Committees, Program Committee Chair, International Advisory Committee, Review Committee, Program Committee Member for contributing either their precious time in reviewing the papers or their effort in monitoring and making the conference a grand success. I also would like to acknowledge the support of IDES and the Association of Computer Electrical Electronics and Communication Engineers (ACEECom) for organising such a platform to welcome the future technology. I also wish to convey my gratitude to McGraw-Hill Education for publishing the registered papers.

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